# 74AHC08; 74AHCT08

# **Quad 2-input AND gate**

Rev. 4 — 26 May 2020

**Product data sheet** 

## 1. General description

The 74AHC708; 74AHC708 are quad 2-input AND gates. Inputs are overvoltage tolerant. This feature allows the use of these devices as translators in mixed voltage environments.

## 2. Features and benefits

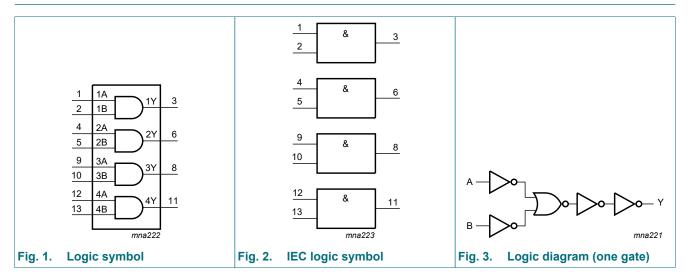
- Wide supply voltage range from 2.0 V to 5.5 V
- Input levels:
  - For 74AHC08: CMOS level
  - For 74AHCT08: TTL level
- · Balanced propagation delays
- · All inputs have a Schmitt-trigger action
- Overvoltage tolerant inputs to 5.5 V
- · High noise immunity
- · CMOS low power dissipation
- ESD protection:
  - HBM EIA/JESD22-A114E exceeds 2000 V
  - MM EIA/JESD22-A115-A exceeds 200 V
  - CDM EIA/JESD22-C101C exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- · Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

# 3. Ordering information

## **Table 1. Ordering information**

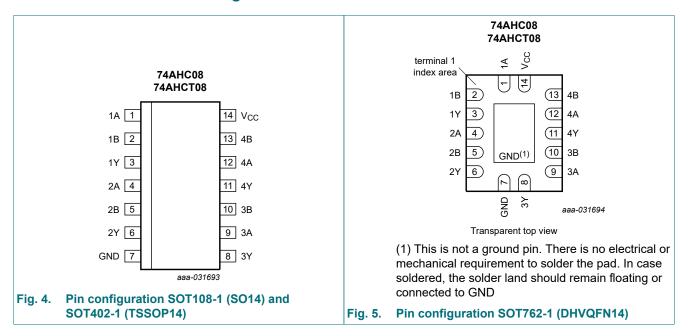
Type number	Package										
	Temperature range	Name	Description	Version							
74AHC08D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1							
74AHCT08D			body width 3.9 mm								
74AHC08PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1							
74AHCT08PW			body width 4.4 mm								
74AHC08BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal	SOT762-1							
74AHCT08BQ			enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm								

# 4. Functional diagram



## 5. Pinning information

## 5.1. Pinning



## 5.2. Pin description

Table 2. Pin description

Pin	Description
1, 4, 9, 12	data inputs
2, 5, 10, 13	data inputs
3, 6, 8, 11	data outputs
7	ground (0 V)
14	supply voltage
	1, 4, 9, 12 2, 5, 10, 13 3, 6, 8, 11 7

# 6. Functional description

#### **Table 3. Function selection**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care$ 

Input		Output
nA	nB	nY
L	X	L
Х	L	L
Н	Н	Н

## 7. Limiting values

### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < -0.5 V	[1]	-20	-	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V	[1]	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$		-	±25	mA
I <sub>CC</sub>	supply current			-	75	mA
I <sub>GND</sub>	ground current			-75	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT402-1 (TSSOP14) package: Ptot derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package: Ptot derates linearly with 9.6 mW/K above 98 °C.

# 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		74AHC08	3	7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	-	-	100	-	-	-	ns/V
	fall rate	V <sub>CC</sub> = 5.0 V ± 0.5 V	-	-	20	-	-	20	ns/V

<sup>[2]</sup> For SOT108-1 (SO14) package: Ptot derates linearly with 10.1 mW/K above 100 °C.

# 9. Static characteristics

**Table 6. Static characteristics** 

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C 1	to +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74AHC0	8									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V <sub>CC</sub> = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V <sub>CC</sub> = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		$I_O = -50 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.4	-	V
		$I_O = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 V$	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μA
Cı	input capacitance		-	3.0	10	-	10	-	10	pF
74AHCT	08				•					·
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -8.0 mA	3.94	-	-	3.8	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
	output voltage	I <sub>O</sub> = 50 μA	-	0	0.1	-	0.1	-	0.1	٧
		I <sub>O</sub> = 8.0 mA	-	-	0.36	-	0.44	-	0.55	٧
l <sub>l</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ

Symbol	Parameter	Conditions		25 °C			to +85 °C	-40 °C t	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
ΔI <sub>CC</sub>		per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other pins at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
Cı	input capacitance		-	3.0	10	-	10	-	10	pF

# 10. Dynamic characteristics

### **Table 7. Dynamic characteristics**

GND = 0 V; For test circuit see Fig. 7.

Symbol	Parameter	Conditions			25 °C		-40 °C	to +85 °C	-40 °C t	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	1
74AHC0	8					'					
t <sub>pd</sub>	propagation	nA, nB to nY; see Fig. 6	[2]								
	delay	V <sub>CC</sub> = 3.0 V to 3.6 V									
		C <sub>L</sub> = 15 pF		-	4.0	8.8	1.0	10.5	1.0	11.0	ns
		C <sub>L</sub> = 50 pF		-	5.6	12.3	1.0	14	1.0	15.5	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	3.0	5.9	1.0	7.0	1.0	7.5	ns
		C <sub>L</sub> = 50 pF			4.2	7.9	1.0	9.0	1.0	10.0	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$	[3]	-	10.0	-	-	-	-	-	pF
74AHCT	08							'	'	'	
t <sub>pd</sub>	propagation	nA, nB to nY; see Fig. 6	[2]								
	delay	V <sub>CC</sub> = 4.5 V to 5.5 V									
		C <sub>L</sub> = 15 pF		-	3.2	6.9	1.0	8.0	1.0	9.0	ns
		C <sub>L</sub> = 50 pF		-	4.2	7.9	1.0	9.0	1.0	10.0	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$	[3]	-	12.0	-	-	-	-	-	pF

- [1] Typical values are measured at nominal supply voltage ( $V_{CC}$  = 3.3 V and  $V_{CC}$  = 5.0 V).
- [2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.
   [3] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

 $P_D = C_{PD} x V_{CC}^2 x f_i x N + \Sigma (C_L x V_{CC}^2 x f_o)$  where:

 $f_i$  = input frequency in MHz,  $f_o$  = output frequency in MHz

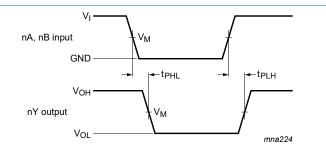
 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## 10.1. Waveform and test circuit



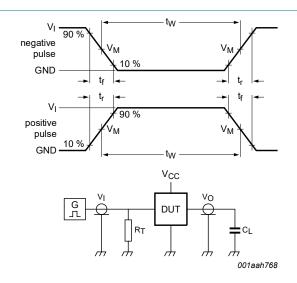
Measurement points are given in Table 8.

 $\ensuremath{V_{\text{OL}}}$  and  $\ensuremath{V_{\text{OH}}}$  are typical voltage output levels that occur with the output load.

Fig. 6. The input (nA, nB) to output (nY) propagation delays

**Table 8. Measurement points** 

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74AHC08	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74AHCT08	1.5 V	0.5V <sub>CC</sub>



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $C_L$  = load capacitance including jig and probe capacitance.

Fig. 7. Test circuit for measuring switching times

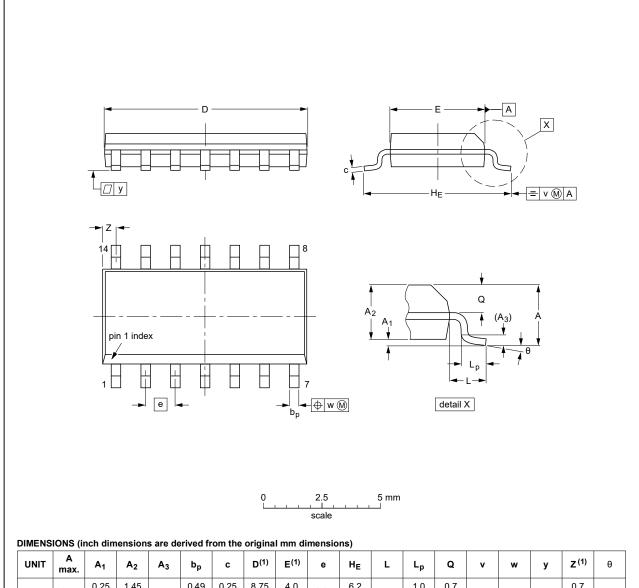
Table 9. Test data

Туре	Input		Load	Test
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	
74AHC08	$V_{CC}$	≤ 3.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74AHCT08	3.0 V	≤ 3.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

# 11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



	UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
i	nches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

#### Note

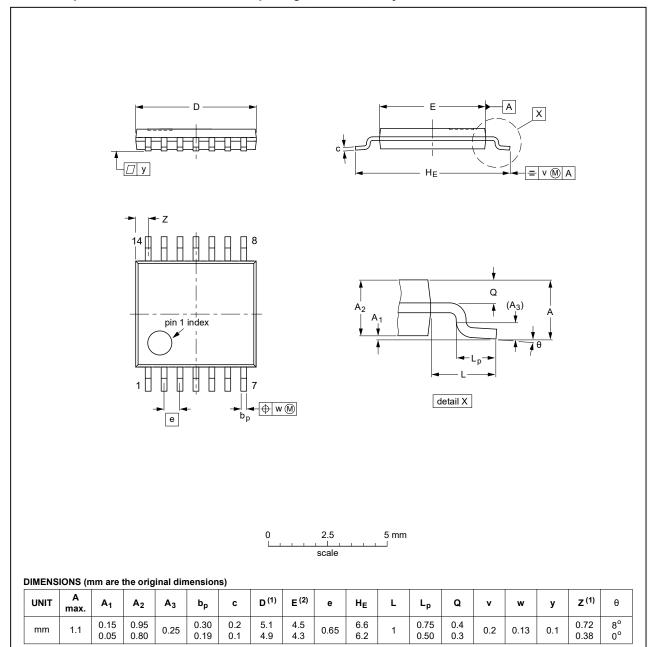
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			<del>99-12-27</del> 03-02-19

Fig. 8. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 9. Package outline SOT402-1 (TSSOP14)

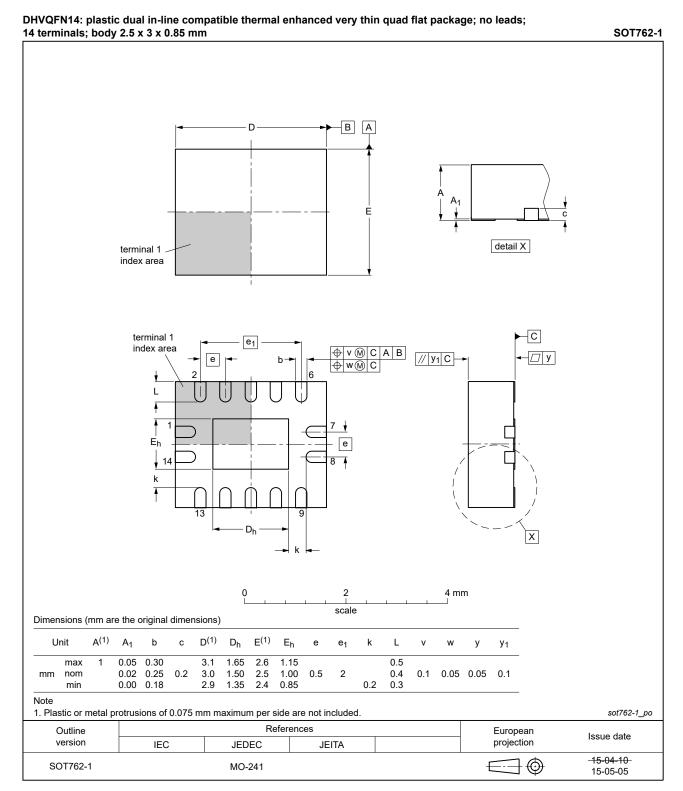


Fig. 10. Package outline SOT762-1 (DHVQFN14)

## 12. Abbreviations

### **Table 10. Abbreviations**

Acronym	Description	
CMOS	Complementary Metal Oxide Semiconductor	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MM	Machine Model	
CDM	Charged Device Model	
TTL	Transistor-Transistor Logic	

# 13. Revision history

## Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AHC_AHCT08 v.4	20200526	Product data sheet	-	74AHC_AHCT08 v.3	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity gu Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section 1 and Section 2 updated.</li> <li>Section 7: Derating values for P<sub>tot</sub> total power dissipation have been updated.</li> <li>Fig. 7: Test circuit corrected (Errata).</li> <li>Package outline drawing of SOT762-1 (Fig. 10) updated.</li> </ul>				
74AHC_AHCT08 v.3	20071114	Product data sheet	-	74AHC_AHCT08 v.2	
Modifications:	of NXP Semiconduct Legal texts have bee Section 3: DHVQFN Section 7: derating v	ors. In adapted to the new co	. •		
74AHC_AHCT08 v.2	19990924	Product specification	-	74AHC_AHCT08 v.1	
74AHC_AHCT08 v.1	19981218	Product specification	-	-	

## 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition	
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.	
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.	
Product [short] data sheet	Production	This document contains the product specification.	

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## **Contents**

1. Ge	neral description	1
2. Fe	atures and benefits	1
3. Or	dering information	1
4. Fu	nctional diagram	2
5. Pir	nning information	2
5.1. F	Pinning	2
5.2. F	Pin description	2
6. Fu	nctional description	3
7. Lir	niting values	3
8. Re	commended operating conditions	3
9. Sta	atic characteristics	4
10. D	ynamic characteristics	5
10.1.	Waveform and test circuit	6
11. P	ackage outline	7
12. A	.bbreviations1	0
13. R	evision history1	0
14. L	egal information1	1

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